

PALM INTRANET

Day : Sunday Date: 8/20/2006

Time: 11:00:44

Inventor Name Search Result

Your Search was:

Last Name = OGIWARA First Name = TOSHIAKI

Application#	Patent#	Status	Date Filed	Title	Inventor Name
06038261	4238455	150	05/11/1979	DENITRIFICATION REACTOR	OGIWARA, TOSHIAKI
<u>08464753</u>	Not Issued	161		PROCESS FOR PRODUCING A HIGH MOLECULAR WEIGHT EPOXY RESIN	OGIWARA, TOSHIAKI
10468425	Not Issued	161		Composition for filling through- holes in printed wiring boards	OGIWARA, TOSHIAKI
10786489	Not Issued	30	02/25/2004	Composition of conductive paste	OGIWARA, TOSHIAKI
10968605	Not Issued	61		Electroconductive paste composition	OGIWARA, TOSHIAKI
60184938	Not Issued	159	02/25/2000	Silver paste composition for forming electrically conductive vias	OGIWARA, TOSHIAKI
60279206	Not Issued	159		Composition for filling through- holes	OGIWARA, TOSHIAKI

Inventor Search Completed: No Records to Display.

To go back use Back button on your browser toolbar.

Back to PALM | ASSIGNMENT | OASIS | Home page

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operat or	Plural s	Time Stamp
L1	1373	(conductive or conductor or electroconduct\$ or thick film) and (maruzen)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 11:57
L2	572	I1 and (pi or pl or polyimide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 11:55
L3	42	maruzen with (pi100 or pi-100 or pl-100 or pl100 or pi117 or pi-117 or pl117 or pl-117 or polyimide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 11:56
L4	20	I3 and (conductive or conductor or electroconduct\$ or thick film)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:08
L5	26343	(conductive or conductor or electroconductive) and (solvent) and (polyimide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:09

8/20/06 12:26:51 PM

EAST Search History

<u> </u>	1					
L6	0	l5 and "252/512-514.ccls"	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:10
L7	3987	252/512-514.ccls.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:10
L8	219	I5 and I7	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:10
L9	1	l8 and (maruzen)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:12
L10	11	l8 and (polyimide with formula)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:14

EAST Search History

L11	1055	I5 and (polyimide with formula)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:15
L12	476	I5 and (polyimide with formula).clm,ab.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:15
L13	467	I12 not I10	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:15

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(FILE 'HOME' ENTERED AT 12:38:30 ON 20 AUG 2006)

FILE 'CAPLUS' ENTERED AT 12:38:42 ON 20 AUG 2006
L1 182 SEA (PI-100 OR PI100 OR PI-117 OR PI117 OR MARUZEN)
L2 12 SEA L1 AND (CONDUCTIVE OR ELECTROCONDUCT? OR PASTE OR THICK FILM)
D 1-12 IALL

FILE 'STNGUIDE' ENTERED AT 12:40:57 ON 20 AUG 2006

FILE HOME

FILE CAPLUS

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FILE STNGUIDE
FILE CONTAINS CURRENT INFORMATION.
LAST RELOADED: Aug 18, 2006 (20060818/UP).